Low Voltage Bias Stabilizer with Enable

- Maintains Stable Bias Current in N-Type Discrete Bipolar Junction and Field Effect Transistors
- Provides Stable Bias Using a Single Component Without Use of **Emitter Ballast and Bypass Components**
- Operates Over a Wide Range of Supply Voltages Down to 1.8 Vdc
- Reduces Bias Current Variation Due to Temperature and Unit-to-Unit Parametric Changes
- Consumes < 0.5 mW at V_{CC} = 2.75 V
- Active High Enable is CMOS Compatible

This device provides a reference voltage and acts as a DC feedback element around an external discrete, NPN BJT or N-Channel FET. It allows the external transistor to have its emitter/source directly grounded and still operate with a stable collector/drain DC current. It is primarily intended to stabilize the bias of discrete RF stages operating from a low voltage regulated supply, but can also be used to stabilize the bias current of any linear stage in order to eliminate emitter/source bypassing and achieve tighter bias regulation over temperature and unit variations. The "ENABLE" polarity nulls internal current, Enable current, and RF transistor current in "STANDBY." This device is intended to replace a circuit of three to six discrete components.

The combination of low supply voltage, low quiescent current drain, and small package make the MDC5001T1 ideal for portable HIBTACTATI communications applications such as:

- Cellular Telephones
- Pagers
- PCN/PCS Portables
- GPS Receivers
- PCMCIA RF Modems
- Cordless Phones
- Broadband and Multiband Transceivers and Other Portable Wireless Products



MDC5001T1



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MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Power Supply Voltage	V _{CC}	15	Vdc
Ambient Operating Temperature Range	T _A	-40 to +85	°C
Storage Temperature Range	T _{stg}	–65 to +150	°C
Junction Temperature	TJ	150	°C
Collector Emitter Voltage (Q2)	V _{CEO}	-15	V
Enable Voltage (Pin 5)	V _{ENBL}	V _{CC}	V

THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit
Total Device Power Dissipation (FR–5 PCB of $1'' \times 0.75'' \times 0.062''$, T _A = 25°C) Derate above 25°C	PD	150 1.2	mW mW/°C
Thermal Resistance, Junction to Ambient	R _{θJA}	833	°C/W
ELECTRICAL CHARACTERISTICS ($T_{\Delta} = 25^{\circ}$ C unless otherwise noted)			C

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Recommended Operating Supply Voltage	V _{CC}	1.8	2.75	10	Volts
Power Supply Current (V _{CC} = 2.75 V) V _{ref} , I _{out} are unterminated See Figure 8	lcc		130	200	μΑ
Q2 Collector Emitter Breakdown Voltage $(I_{C2} = 10 \ \mu A, I_{B2} = 0)$	V _{(BR)CEO2}	15	MA		Volts
Reference Voltage (V _{ENBL} = V _{CC} = 2.75 V, V _{out} = 0.7 V) (I_{out} = 30 μ A) (I_{out} = 150 μ A) See Figure 1	Vref	2.050 2.110	2.075 2.135	2.100 2.160	Volts
$\label{eq:constraint} \begin{array}{ c c c } \hline Reference \mbox{ Voltage } (V_{ENBL} = V_{CC} = 2.75 \mbox{ V, } V_{out} = 0.7 \mbox{ V, } \\ -40^\circ C \leq T_A \leq] + 85^\circ C) \\ \hline V_{CC} \mbox{ Pulse Width } = 10 \mbox{ mS, Duty Cycle } = 1\% \\ \hline (I_{out} = 10 \mbox{ \muA}) \\ \hline (I_{out} = 100 \mbox{ \muA}) \\ \hline (I_{out} = 100 \mbox{ \muA}) \\ \hline See \mbox{ Figures 2 and 11} \end{array}$	ΔV _{ref}		±5.0 ±15 ±25	±10 ±30 ±50	mV
PLEASERALSEN	<u>.</u>	<u>.</u>	<u>.</u>	<u>.</u>	<u>.</u>

The following SPICE models are provided as a convenience to the user and every effort has been made to insure their accuracy. However, no responsibility for their accuracy is assumed by ON Semiconductor.

.MODEL	.MODEL Q4 NPN .MODEL Q1, Q2 PNP		RESISTOR VALUES		
BF = 136 BR = 0.2 CJC = 318.6 f CJE = 569.2 f CJS = 1.9 p EG = 1.215 FC = 0.5 IKF = 24.41 m	NE = 1.6 NF = 1.005 RB = 140 RBM = 70 RC = 180 RE = 1.6 TF = 553.6 p TR = 10 n	BF = 87 BR = 0.6 CJC = 800E-15 CJE = 46E-15 EG = 1.215 FC = 0.5 IKF = 3.8E-04 IKR = 2.0	NK = 0.5 NR = 1.0 RB = 720 RBM = 470 RC = 180 RE = 26 TF = 15E-9 TR = 50E-09	R1 = 12 K R2 = 6 K R3 = 3.4 K R4 = 12 K R5 = 20 K R6 = 40 K	
IRH = 0.25 IRB = 0.0004 IS = 256E-18 ISC = 1 f ISE = 500E-18 ITF = 0.9018 MJC = 0.2161 MJE = 0.3373 MJS = 0.13 NC = 1.09	VAF = 267.6 VAR = 12 VJC = 0.4172 VJE = 0.7245 VJS = 0.39 VTF = 10 XTB = 1.5 XTF = 2.077 XTI = 3	IKB = 0.9E-3 IS = 1.027E-15 ISC = 10E-18 ISE = 1.8E-15 ITF = 2E-3 MJC = 0.2161 MJE = 0.2161 NC = 0.8 NE = 1.38 NF = 1.015	VAF = 54.93 VAF = 20 VAR = 20 VJC = 0.4172 VJE = 0.4172 VTF = 10 XTB = 1.5 XTF = 2.0 XTI = 3	These models can be retrieved electronically by accessing the ON Semiconductor Web page at http://design_net.sps.mot.com/models and searching the section on	
	PLEAS	CONTRACT REPRESENT	E OBSON	SMALLBLOCK* models	

TYPICAL OPEN LOOP CHARACTERISTICS



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TYPICAL OPEN LOOP CHARACTERISTICS

(Refer to Circuits of Figures 10 through 15)



Figure 6. V_{ref} versus V_{enable} @ V_{CC} and I_{out}

TYPICAL CLOSED LOOP PERFORMANCE

(Refer to Circuits of Figures 16 & 17)



OPEN LOOP TEST CIRCUITS



NOTE 1: V_{BE3} is used to simulate actual operating conditions that reduce V_{CE2} & H_{FE2}, and increase I_{B2} & V_{ref}.

CLOSED LOOP TEST CIRCUITS



Figure 17. RF Stage I_{C3} versus T_{A} Test Circuit

APPLICATION CIRCUITS



Step 5: Calculate Nominal R5 = $(V_{CC} - V_{ref}) \div (I_{C3} + I_{out})$. Tweak as desired.

Figure 18. Class A Biasing of a Typical 900 MHz BJT Amplifier Application

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- Step 2: Insure that Min V_{ENBL} is \geq minimum indicated in Figures 5 and 6.
- Step 3: Choose bias current, I_D , and determine needed gate-source voltage, V_{GS} .
- Step 4: Choose I_{out} keeping in mind that too large an I_{out} can impair MDC5000 $\Delta V_{ref} / \Delta T_J$ performance (Figure 2) but too large an R6 can cause I_{DGO} & I_{GSO} to bias on the FET.
- Step 5: Calculate R6 = $(V_{GS} + E_{GS}) \div I_{out}$
- Step 6: From Figure 1, read V_{ref} for V_{CC} & I_{out} chosen
- Step 7: Calculate Nominal R5 = $(V_{CC} V_{ref}) \div (I_D + I_{out})$ Tweak as desired.

Figure 19. Class A Biasing of a Typical 890 MHz Depletion Mode GaAs FET Amplifier

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SC-88 (SOT-363) CASE 419B-01 **ISSUE G** G v NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. Ą 2. CONTROLLING DIMENSION: INCH. S -B-MILLIMETERS INCHES MIN MAX DIM. MIN MAX A 0.071 0.087 B 0.045 0.053 ¥ 1.80 2.20 1.35 1.15 0.031 0.043 0.004 0.012 C 0.80 1.10 н

PACKAGE DIMENSIONS



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